



NCE N and P-Channel Enhancement Mode Power MOSFET

D2 Description The NCE6602 uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge. This device is suitable for use as a Battery protection or in other Switching application. G1 G2 **General Features** N-channel P-channel • N-Channel Schematic diagram • V_{DS} = 30V,I_D = 3.5A S D 8 $R_{DS(ON)}$ <58m Ω @ V_{GS}=10V $R_{DS(ON)} < 95m\Omega @ V_{GS}=4.5V$ S • P-Channel 6602 $V_{DS} = -30V, I_{D} = -2.7A$ $R_{DS(ON)} < 100 m\Omega @ V_{GS} = -10V$ $R_{DS(ON)} < 150 m\Omega @ V_{GS} = -4.5 V$ R Marking and pin Assignment Low On-Resistance • Low Input Capacitance • Fast Switching Speed • Low Input/Output Leakage

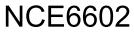
Package Marking and Ordering Information

	Device Marking Device		Device Package Reel Size		Tape width	Quantity				
Ī	6602	NCE6602	TSOT23-6L	Ø180mm	8mm	3000 units				
	Absolute Maximum Ratings (T. -25° unless otherwise noted)									

TSOT23-6L top view

Absolute Maximum Rating	$gs(T_A=25 \bigcirc umess of$	nei wise noteu)		1	
Parame	Symbol	N-Channel	P-Channel	Unit	
Drain-Source Voltage	V _{DS}	30	-30	V	
Gate-Source Voltage	V _{GS}	±20	±20	V	
Continuous Drain Current	T _A =25℃		3.5	-2.7	A
	T _A =70℃	I _D	3	-2.1	
Pulsed Drain Current (Note 1)	I _{DM}	20	-15	А	
Maximum Power Dissipation T _A =25°C		PD	1.2		W
Operating Junction and Storage T	TJ,TSTG	-55 To 150	-55 To 150	°C	
Thermal Characteristic					
Thermal Resistance, Junction-to-A	Ambient (Note2)	R _{0JA}	N-Ch	104	°C/W
Thermal Resistance, Junction-to-A	R _{0JA}	P-Ch	104	°C/W	





N-CH Electrical Characteristics (T_A=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics				•		
Drain-Source Breakdown Voltage	BV _{DSS}	BV _{DSS} V _{GS} =0V I _D =250μA		33	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)				•		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.2	1.5	2.2	V
Drain Course On State Desistence	P	V _{GS} =10V, I _D =3.5A	-	36	58	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =2A	-	60	95	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =3.1A	-	4	-	S
Dynamic Characteristics (Note4)				•		
Input Capacitance	C _{lss}		-	210	-	PF
Output Capacitance	C _{oss}	V _{DS} =15V,V _{GS} =0V, F=1.0MHz	-	35	-	PF
Reverse Transfer Capacitance	C _{rss}		-	23	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	4.5	-	nS
Turn-on Rise Time	tise Time t_r V_{DD} =15V, RL=3 Ω		-	1.5	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{GEN} =6 Ω	-	18.5	-	nS
Turn-Off Fall Time	t _f		-	15.5	-	nS
Total Gate Charge	Qg		-	5	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =15V,I _D =3.5A,	-	0.55	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	1	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =3.5A	-	0.8	1.2	V
Diode Forward Current (Note 2)	I _S		-	-	3.5	Α

Notes:

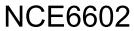
1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, t \leq 10 sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production





P-CH Electrical Characteristics (T_A=25℃unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-30	-33	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-30V,V _{GS} =0V	-	-	-1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	$V_{GS(th)}$	V _{DS} =V _{GS} ,I _D =-250µA	-1	-1.6	-2.5	V
Durin Origina Origination Designation	5	V _{GS} =-10V, I _D =-2.7A	-	69	100	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-2A	-	110	150	mΩ
Forward Transconductance	g fs	V _{DS} =-10V,I _D =-2.7A		2	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{Iss}	- V _{DS} =-15V,V _{GS} =0V, - F=1.0MHz -		199	-	PF
Output Capacitance	C _{oss}			47	-	PF
Reverse Transfer Capacitance	Crss			28	-	PF
Switching Characteristics (Note 4)	·			•		•
Turn-on Delay Time	t _{d(on)}		-	8	-	nS
Turn-on Rise Time	tr	V _{DD} =-15V,R _L =15Ω	-	5	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =-10V,R _{GEN} =6Ω	-	12	-	nS
Turn-Off Fall Time	t _f		-	4	-	nS
Total Gate Charge	Qg		-	5	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =-15V,I _D =-2.7A,V _{GS} =-10V	-	0.7	-	nC
Gate-Drain Charge	Q _{gd}		-	1.1	-	nC
Drain-Source Diode Characteristics			•	•		
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-2.7A	-	-	-1.2	V

Notes:

- **1.** Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production





N- Channel Typical Electrical and Thermal Characteristics

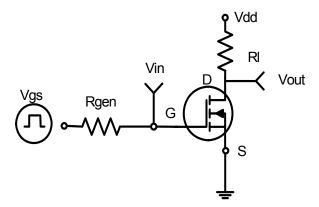
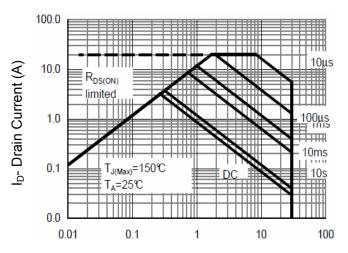
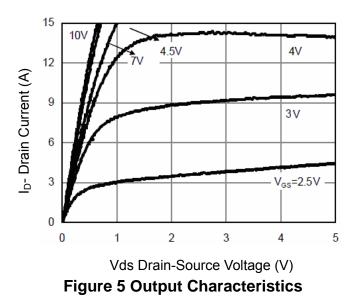


Figure 1:Switching Test Circuit



Vds Drain-Source Voltage (V) Figure 3 Safe Operation Area



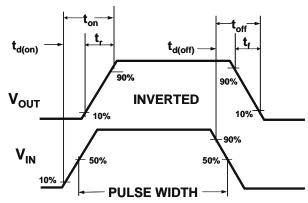


Figure 2:Switching Waveforms

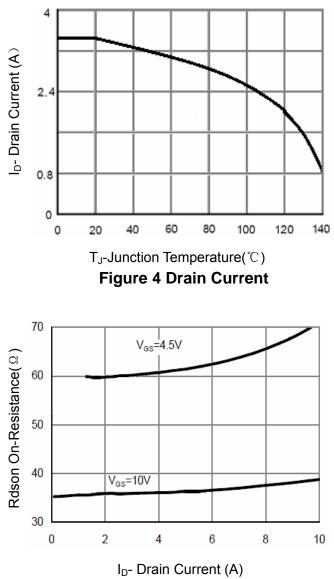
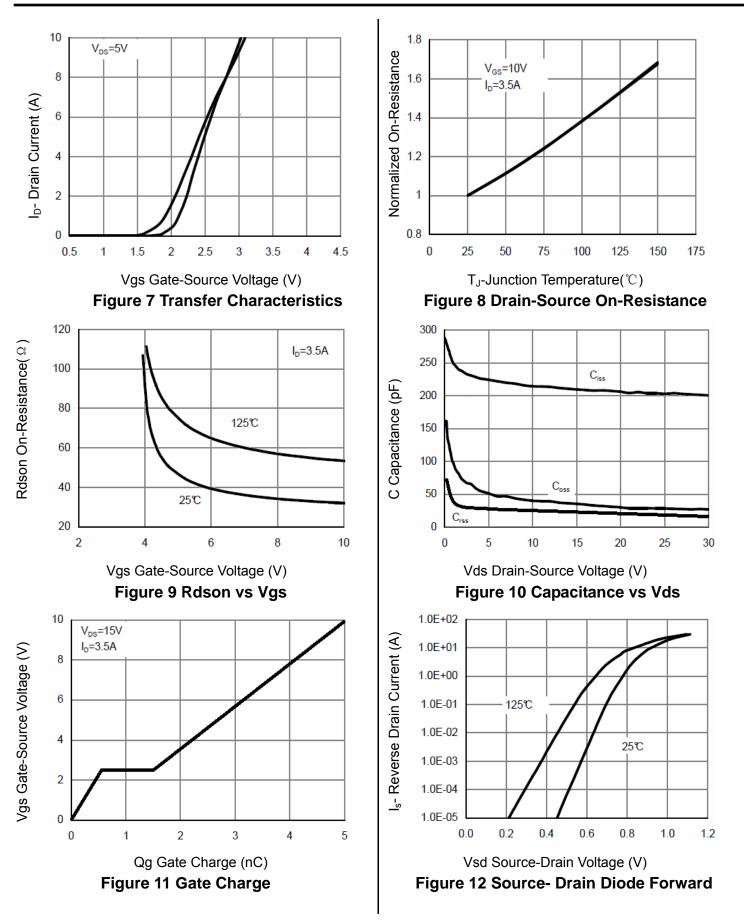


Figure 6 Drain-Source On-Resistance



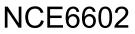
Pb Free Product

NCE6602









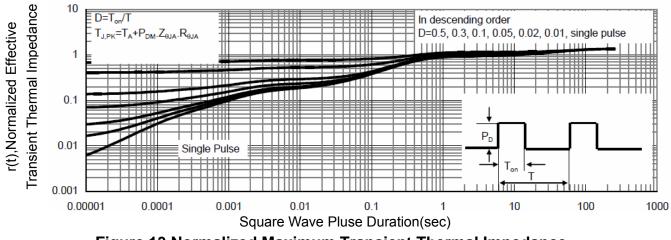
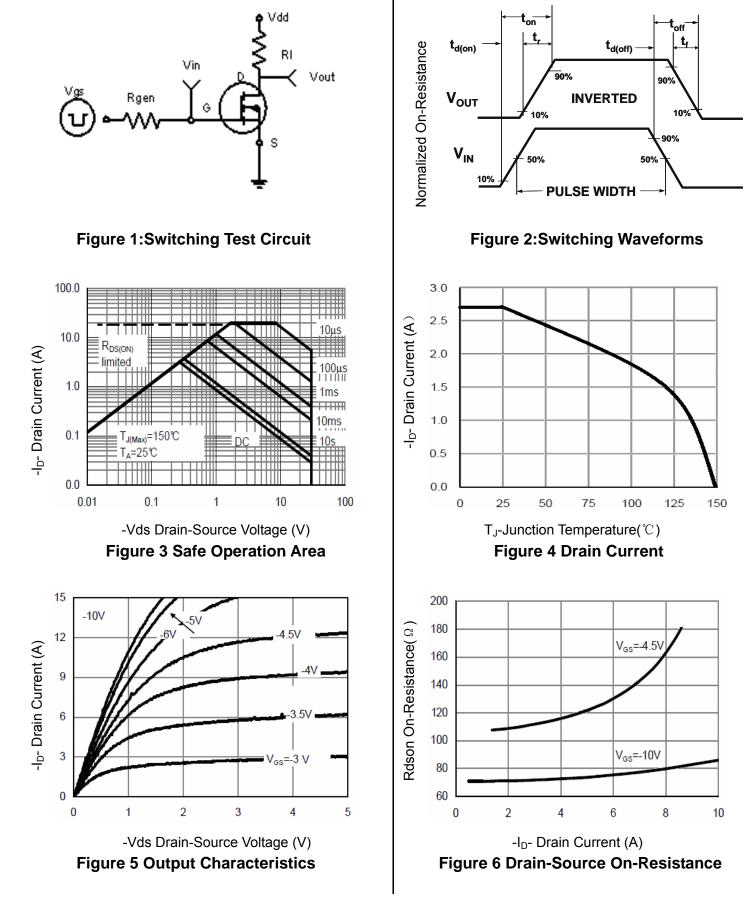


Figure 13 Normalized Maximum Transient Thermal Impedance





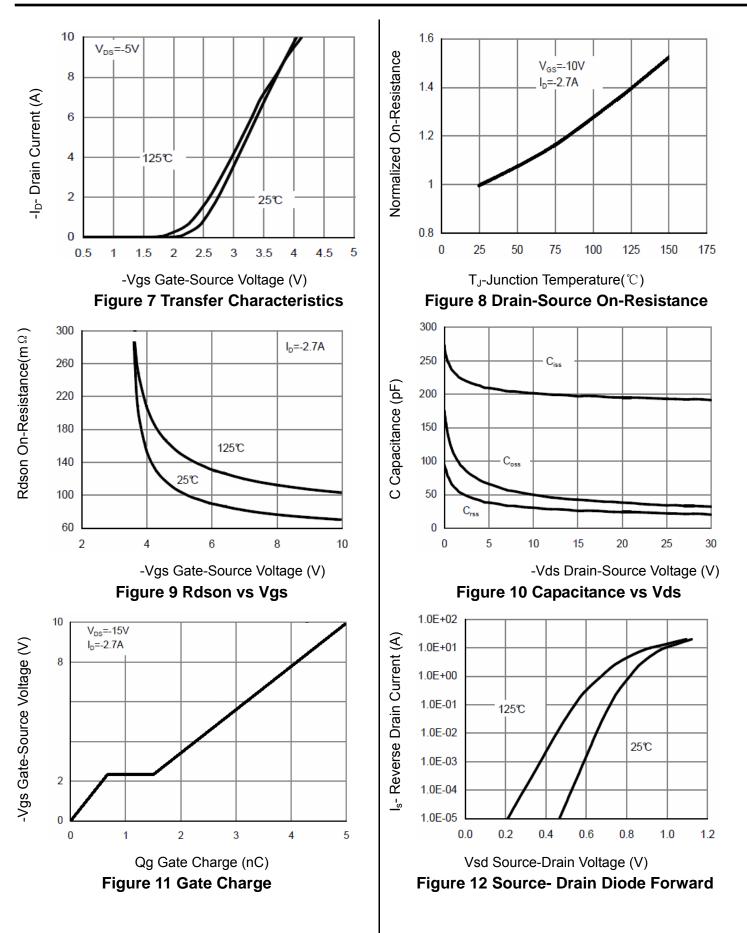
P- Channel Typical Electrical and Thermal Characteristics





Pb Free Product

NCE6602





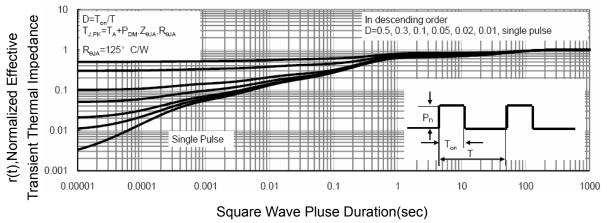


Figure 13 Normalized Maximum Transient Thermal Impedance

Pb Free Product

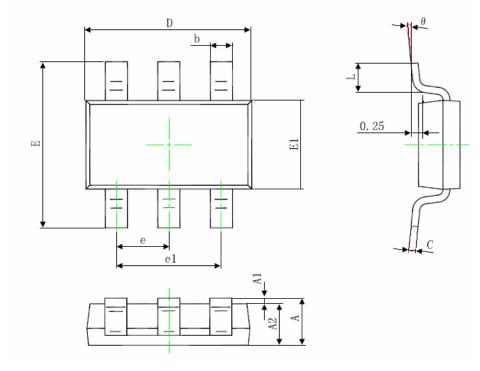
NCE6602







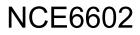
TSOT23-6L Package Information



Symbol	Dimensions Ir	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α		0.900		0.035	
A1	0.000	0.100	0.000	0.004	
A2	0.700	0.800	0.028	0.031	
b	0.350	0.500	0.014	0.020	
с	0.080	0.200	0.003	0.008	
D	2.820	3.020	0.111	0.119	
E1	1.600	1.700	0.063	0.067	
E	2.650	2.950	0.104	0.116	
е	0.95 (E	BSC)	0.037(BSC)		
e1	1.90 (E	BSC)	0.075(BSC)		
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	







Attention:

- Any and all NCE power products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your NCE power representative nearest you before using any NCE power products described or contained herein in such applications.
- NCE power assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all NCE power products described or contained herein.
- Specifications of any and all NCE power products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.
- NCE power Semiconductor CO.,LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all NCE power products(including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of NCE power Semiconductor CO.,LTD.
- Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. NCE power believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the NCE power product that you intend to use.
- This catalog provides information as of Sep, 2010. Specifications and information herein are subject to change without notice.